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## Self-healing in fractured GaAs nanowires

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### Abstract

Molecular dynamics simulations are performed to investigate a spontaneous self-healing process in fractured GaAs nanowires with a zinc blende structure. The results show that such self-healing can indeed occur *via* re-bonding of Ga and As atoms across the fracture surfaces, but it can be strongly influenced by several factors, including wire size, number of healing cycles, temperature, fracture morphology, oriented-attachment and atomic diffusion. For example, it is found that the self-healing capacity is reduced by 46% as the lateral dimension of the wire increases from 2.3 to 9.2 nm, and by 64% after 24 repeated cycles of fracture and healing. Other factors influencing the self-healing behavior are also discussed.

*Keywords:* GaAs nanowires; self-healing; size effect; multiple healing; molecular dynamics

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## 1. Introduction

Self-healing refers to autonomous processes of restoring damaged materials to their original properties. Such behaviors are widely observed in natural materials, particularly in biomaterials, *e.g.*, the healing of a small cut in skin and fractured bones. Mimicking biological systems, a number of synthetic materials have now been designed with the ability to spontaneously restore their mechanical properties and functions upon damage [1–5]. Over the last few years, self-healing has been observed in a wide range of nanostructured materials such as ceramic nanocrystals, carbon nanotube and graphene [6–9]. To the best of our knowledge, however, all the man-made self-healing materials reported in the literature require some forms of external intervention, such as temperature, pressure, and manual fluid injection. Recently, a truly spontaneous self-healing of fractured GaAs nanowires (NWs) was observed in *in-situ* deformation experiments inside a transmission electron microscope under near vacuum conditions [10]. It has been shown from molecular dynamics simulations that the re-bonding of Ga and As atoms across fracture surfaces plays a key role in restoring these NWs [11].

Since relatively smooth fracture surfaces can be realized in structures with ultrathin lateral dimensions, it seems that self-healing may be an intrinsic property of one dimensional nanomaterials [11-15]. However, self-healing was rarely observed in GaAs NWs with lateral dimensions more than 12 nm. Moreover, there is also a practical interest to develop materials that can achieve multiple healing cycles [5]. Our recent *in-situ* observations have revealed that GaAs NWs possess the ability to heal themselves when subjected to repeated fractures [10]. However, it has been rather difficult to quantify the healing behavior using experiments. Here we show that these issues can be at least partially addressed with numerical simulations.

In this paper, molecular dynamics simulations are performed to investigate the self-healing behavior of GaAs NWs, with focusing on two important issues: one is how GaAs NWs lose the self-healing capacity as their lateral dimensions increase and the other is concerned with the effect

of repeated fracture on the healing efficiency. In addition, the effects of some other factors such as temperature, oriented-attachment, and atomic diffusion are also investigated.

## 2. Computational methods

An as-synthesized GaAs NW has a zinc-blende structure with a three-fold symmetry around the [111] axis and (110) side facets [16]. Fig. 1(a) shows a typical transmission electron microscopy image of an individual GaAs NW and Fig. 1(b) illustrates a typical computational model, generated by Visual Molecular Dynamics [17], with a cross-sectional dimension of **5.5 nm** and an aspect ratio of 6:1. Generally, NWs are made of an ordered sequence of three basic structure modules of tetrahedral bonding [18]. Here, a super-cell concept is adopted. Specifically, a vacuum region of 3 nm is attached on the outside (lateral) surface to ensure the traction-free condition. Periodic boundary conditions are implemented along all directions. To study size effect, the lateral dimension of NWs ranges from **1.4 to 9.2 nm**. Analyses are carried out at temperature ranging from 300 to 1200 K to quantify the temperature effect on the self-healing behavior. A typical NW with the lateral dimension of **5.5 nm** is selected to investigate the influence of repeated fracture and healing on its mechanical properties.

A potential function consisting of two-body (Ga-Ga, Ga-As and As-As) and three-body covalent interactions (Ga-As-Ga and As-Ga-As) with the form of

$$V = \sum_{i<j} V_{ij}^{(2)}(r_{ij}) + \sum_{i,j<k} V_{jik}^{(3)}(r_{ij}, r_{ik}) \quad (1)$$

is used in the molecular dynamics simulations, where  $r_{ij}$  is the distance between atoms  $i$  and  $j$  [19].

The two-body part can be written as

$$V_{ij}^{(2)}(r_{ij}) = A_{ij} \left( \frac{\sigma_i + \sigma_j}{r_{ij}} \right)^{\eta_{ij}} + \frac{Z_i Z_j}{r_{ij}} e^{-r_{ij}/\lambda_s} - \frac{\alpha_i Z_j^2 \alpha_j Z_i^2}{2r_{ij}^4} e^{-r_{ij}/r_{as}} - \frac{W_{ij}}{r_{ij}^6}. \quad (2)$$

The first term represents the steric repulsion, which is described by the strength prefactors  $A_{ij}$ , ionic radii  $\sigma_i$  and  $\sigma_j$ , and the exponent of steric repulsion  $\eta_{ij}$ . The second term is the screened Coulomb



interaction due to charge transfer with  $Z_i$  and  $Z_j$  being effective atomic charges and  $r_{1s}$  a screen length. The third term corresponds to the charge dipole interaction due to the large polarizability of negative ions, where  $r_{4s}$  is a screen length. The last term is the induced dipole-dipole interaction containing the van der Waals strength  $W_{ij}$ .

The three-body term in Eq. (1) combines the spatial and angular dependence in the form of

$$V_{jik}^{(3)}(r_{ij}, r_{ik}) = B_{jik} \exp\left(\frac{l}{r_{ij} - r_0} + \frac{l}{r_{ik} - r_0}\right) \times \frac{(\cos \theta_{jik} - \cos \bar{\theta}_{jik})^2}{1 + C_{jik} (\cos \theta_{jik} - \cos \bar{\theta}_{jik})^2}, \quad (3)$$

$$\times \Theta(r_0 - r_{ij}) \Theta(r_0 - r_{ik})$$

where  $B_{jik} = 7.9 \times 10^{-19}$  J is the strength of interaction,  $\theta_{jik}$  the angle between  $r_{ij}$  and  $r_{ik}$ , and  $C_{jik} = 20$  and  $\bar{\theta}_{jik} = 109.47^\circ$  are constants.  $\Theta(r_0 - r_{ij})$  is a step function. The characteristic length  $l$  and the three-body cutoff length  $r_0$  are set to **0.1 and 0.38 nm**, respectively. The two-body interaction is truncated at  $r_c = \mathbf{0.75}$  nm. To keep the potential and its first derivative continuous at  $r_c$ , the two-body interaction is shifted with

$$V_{(ij)}^{(2 \text{ shifted})}(r) = \begin{cases} V_{ij}^{(2)}(r) - V_{ij}^{(2)}(r_c) - (r - r_c)(dV_{ij}^{(2)}(r)/dr)_{r=r_c} & r \leq r_c \\ 0 & r > r_c \end{cases}. \quad (4)$$

Parameters of the two-body potential are listed in Table 1 [19].

To simulate uniaxial tensile loading, a deformation increment along the [111] direction is applied in two steps: a modified isothermal-isobaric ensemble is firstly used to stretch a GaAs NW with a strain rate of  $0.001 \text{ ps}^{-1}$  for 1 ps [20]; and then the axial strain is held while the NW is relaxed for 6 ps *via* a canonical ensemble to obtain its mechanical parameters [21]. In each loading step, the nominal strain is applied with a small increment of 0.1%. The attaching operation is accomplished by a similar technique as the tensile loading, but with a minus strain rate ( $-0.001 \text{ ps}^{-1}$ ). **Although the strain rate in the simulations is much higher than that in experiments, the**

simulated Young's modulus, strength and fracture behavior of NWs are consistent with *in-situ* tests. Since these are the most critical properties in the healing process under study, we believe that the atomistic simulations are suitable for the present study. All samples are relaxed for 20 ps before stretching or attaching. The stress tensor is calculated by a modified virial formula [22]. More discussion on numerical simulations can be found in Ref. [23]. All the calculations are carried out by using the DL\_POLY2.20 package [21].

It is shown that, due to the higher stress state in the surface area of NWs [24–27], the Young's modulus of NWs varies with their lateral dimensions. This phenomenon can be described by the employed interatomic potential. The predicted size-dependent Young's modulus of GaAs NWs is consistent with recent *in-situ* compression tests [28]. Surface properties of GaAs for the (100), (110) and (111) surfaces predicted by the present interatomic potential are also in agreement with *ab initio* calculations and experimental measurements such as the (100) surface reconstruction [19]. These factors are of significance in characterizing the interaction between two fractured free surfaces, where self-healing occurs along (111) planes.

### 3. Results

#### 3.1 Self-healing process

The self-healing behavior of a fractured GaAs NW is assessed in three steps: loading, self-healing and re-loading. First, a uniaxial tensile load is applied on a GaAs NW until it fractures. Then the two fractured sections are attached along the common axis. Finally, a uniaxial tensile load is re-applied and the mechanical properties of the restored NW are evaluated.

As shown in Fig. 2(a), a typical self-healing process consists of three stages: attaching, contacting and healing. (i) When the distance between two fracture surfaces is larger than 1.0 nm, there is no detectable interaction. (ii) As the distance reduces from 1.0 to 0.7 nm, substantial surface attraction emerges. The attractive force per unit area is about 0.1 GPa, which enables the rebuilding of a small amount of broken Ga-As bonds between two fracture surfaces. (iii) With further

reduction in distance, the surface attraction force per unit area between two fracture surfaces reaches a maximum of 0.87 GPa, which is much stronger than that in the contacting stage. The two peaks of surface attraction in Fig. 2(a) correspond to two typical healing events: partial healing in rough regions (peak A) and full healing of the fractured NW (peak B). The tensile test on a self-healed GaAs NW shows that the tensile strength can reach 7.19 GPa. In comparison with its original strength of 9.27 GPa, the healing efficiency is 78%; see Fig. 2(b). However, the Young's modulus (138.0 GPa) of the self-healed GaAs NW is almost the same as that of the virginal sample (138.7 GPa). Here, it is of interest to note that the second brittle failure happens at the same location. For a detailed description of the self-healing process, the reader is referred to Ref. [11].

### 3.2 Size effect

*In-situ* tensile tests on pristine GaAs NWs have shown that their mechanical behaviors are strongly size-dependent. When their cross-sectional dimensions exceed a critical size around 2.3 nm, GaAs NWs are dominantly brittle; otherwise, they exhibit considerable plastic deformation; see Fig. 3(a). As the lateral dimension increases from 1.4 to 9.2 nm, the Young's modulus reduces by 6% from 147.5 to 138.1 GPa, while the tensile strength does not exhibit a clear monotonic trend; see Fig. 3(b). GaAs NWs with lateral dimensions less than 2.3 nm (*e.g.*, the cases of 1.4 and 1.9 nm in Fig. 3) possess lower tensile strengths. As the dimension increases from 2.3 to 9.2 nm, the tensile strength decreases by 1% from 9.33 to 9.24 GPa. It is seen from Fig. 3(a) that the NW with a lateral dimension of 1.4 nm exhibits the biggest elongation of 30%, in contrast to that of ~9% for brittle failure. In this extreme case, the plastic elongation leads to the formation of a single atom chain, similar to the behavior of ultra-thin metal NWs [29]; see insets in Fig. 3(a).

Fig. 4(a) illustrates five adjacent Ga-As layers, each layer representing one module of the tetrahedral bonding [18]. The brittle fracture initiates through breaking Ga-As bonds at the middle layer, which subsequently develops into two fracture surfaces; see Fig. 4(b). Breaking bonds also happen at neighboring layers, which may lead to the formation of stripping flaps as shown in Fig.

4(c). These stripping flaps eventually deposit on the fracture surfaces and result in surface roughness. The larger the lateral dimension of a GaAs NW, the stronger this feature is.

The joining of materials without heating is usually referred to as cold-welding [30]. Here, our attention is focused on the self-healing of GaAs NWs after brittle fracture. As shown in Fig. 5(a), the roughness of fracture surfaces increases with the increase in the lateral dimension of a GaAs NW. When the lateral dimension is less than 5.5 nm, roughness is only 1-2 monolayer thick. However, for a NW with the lateral dimension of 9.2 nm, the thickness of its rough region reaches about 2 nm. The measured surface attraction (defined as the maximum attractive traction during the healing stage) decreases by 65% from 1.74 to 0.61 GPa as the lateral dimension increases from 2.3 to 9.2 nm. As a result, the healing efficiency reduces by 45% from 84% to 46%; see Fig. 5(b).

### 3.3 Repeated fracture

Based on simulations on repeated fracture and healing of GaAs NWs, the restored tensile strength reduces by 64% from 7.19 to 2.56 GPa in 24 healing cycles. The restored tensile strength drops continuously during the first 24 cycles and then remains stable around 2.50 GPa, which accounts for 27% of the virginal strength (9.27 GPa); see Fig. 6(a). Repeated fracture also causes a reduction in the restored Young's modulus. Specifically, during the first 22 healing cycles, the restored Young's modulus decreases by 4% from 138.0 to 132.1 GPa. After that, the Young's modulus fluctuates in a range of 7% around 120.0 GPa, as shown in Fig. 6(b). Also, repeated fracture intensifies the roughness of fracture surfaces due to the mismatch of two fractured sections during the attaching operation; see the surface pattern at the 11th healing cycle in Fig. 7.

### 3.4 Temperature effect

As temperature increases from 300 to 1200 K, the healing efficiency fluctuates between 60% (at 1000 K) and 81% (at 700 K). Similarly, the restored Young's modulus fluctuates from 136.7 to 138.2 GPa, as shown in Fig. 8(a). Compared to the Young's modulus of 138.7 GPa for the virginal sample, at least 99% restoration has been achieved. The surface attraction undergoes a wide

fluctuation from 0.81 to 1.21 GPa. The strongest surface attraction occurs at 700 K, which coincides with the best healing efficiency. The worst healing efficiency at 1000 K corresponds to a case of weak surface attraction; see Fig. 8(b). It is worth noting that, however, the influence of temperature analyzed here only addresses instant Ga-As re-bonding without the contribution of atomic diffusion.

### 3.5 Atomic diffusion

To accelerate atomic diffusion, the GaAs NW subjected to 31 healing cycles is annealed at 1400 K with the annealing time varying from 0.1 to 5 ns. The results show that, with an annealing treatment of 0.1 ns, the healing efficiency is substantially improved from 26 % to 68%, as shown in Fig. 9. When the annealing time is beyond 1 ns, the healing efficiency fluctuates between 77% and 84%, with an average value of 80%. Patterns at the healing sections indicate that atoms near the fracture sites spontaneously diffuse to fill gaps between two surfaces and restore the original [111]-orientated lattice structure. However, due to the rather rough fracture morphology generated after multiple healing cycles, atoms on the fracture surfaces cannot completely return to their original (110) orientations. Instead, small (111) plane reconstructs are observed at local regions; see insets of Fig. 9.

## 4. Discussion

### 4.1 Factors that facilitate self-healing

Surface attraction appears to be the key factor in a self healing process. When a GaAs NW is subjected to tensile loading, fracture mainly occurs between two neighboring (111) planes. The relatively smooth fracture surfaces due to its ultrathin lateral dimension provide a precondition for self-healing. Here, two opposite fracture surfaces are occupied by oppositely charged Ga and As atoms. As the distance between two fracture surfaces falls below 1.0 nm, surface attraction emerges as a result of the near-field electrostatic interaction. At a long distance, the Coulomb interaction between two fracture surfaces quickly declines due to the alternate arrangement of oppositely charged Ga and As ions. At smaller distances, surface attraction can be strong enough to pull those

atoms located at opposite fracture surfaces together and induce the Ga-As re-bonding. The original structure of a GaAs NW can be mostly restored *via* large scale re-bonding at fractured sites. The similar role of surface attraction was also discovered in ZnO and gold nanocrystallites [30–32], except that, due to the non-polar nature of gold atoms, forces such as the van der Waals interaction are likely to play a more important role. As the lateral dimension of GaAs NWs increases, the dramatically reduced surface attraction leads to poor healing efficiency. This explains why the self-healing behavior is rarely observed in GaAs NWs with lateral dimensions exceeding 12 nm [10].

An oriented-attachment operation can be introduced to facilitate the self-healing of fractured GaAs NWs. Such an operation ensures that atoms and Ga-As bonds can return to their original positions when re-bonding happens. For example, healing always occurred instantaneously between two gold NWs with the same growth orientation [30]. The effect of oriented-attachment is reflected by a deviation of the healing efficiency from the attenuation trend during first 24 repeated healing cycles; see Fig. 6(a). Well aligned fractured sections along [111] orientation produces a better efficiency and vice versa. Similar mechanism was also reported in PdSe nanocrystals [33,34].

Atomic diffusion can be helpful in further removing the mismatched Ga-As bonds at healing sites and moving atoms to their original [111]-oriented lattice structure. Such a rearrangement *via* re-bonding experiences an energy reduction by reducing the surface area. It is worth noting that, however, the diffusion of atoms also introduces intrinsic irregularities on fracture surfaces. As the sample is annealed beyond 1 ns, atomic diffusion reaches a dynamical equilibrium, which causes a slight vibration of healing efficiency around 80% with the amplitude of 3%. Re-bonding facilitated by atomic diffusion has been reported in most nanomaterials [35–37].

#### 4.2 *Factors that hinder self-healing*

Several factors such as fracture surface roughness, impurities, local defects and thermal vibration can be obstacles to self-healing of a fractured GaAs NW. Although typical rough sections

on fracture surfaces are only several atoms thick, they can prevent more atoms from entering the effective range of surface attraction. Roughness also causes the mismatch of atoms during a healing process. Thus, the original structure of a NW cannot be entirely restored. The local defects left in a self-healed GaAs NW become the source of damage nucleation during re-loading. As a result, the self-healed GaAs NW shows a lower Young's modulus and tensile strength. The restored Young's modulus and healing efficiency decrease as the healing cycles increase. Due to the ultra-thin size, roughness caused by repeated fracture reaches a stable state after 24 healing cycles. Afterwards, the number of rebuilt Ga-As bonds keeps constant during subsequent healing cycles. This leads to an approximately constant tensile strength, which is dependent on the total number of restored Ga-As bonds. However, the random mismatch between atoms occurring in isolated healing events results in a fluctuation of Young's modulus. The negative influence of surface roughness on self-healing has also been recognized in polymers [38–40]. Furthermore, the healing efficiency fluctuates as the attaching process is operated at diverse temperatures, which is due to the stochastic Ga-As re-bonding between fractured sites resulted by the thermal motion of surface atoms and unstable oriented-attachment operation.

## 5. Conclusions

Based on molecular dynamics simulations, we have shown that the self-healing behavior of fractured GaAs NWs depends on their lateral dimensions and the number of healing cycles. Sufficiently smooth fracture surfaces and strong surface attraction appear to be a precondition for self-healing of fractured GaAs NWs. The surface attraction due to the electrostatic interaction in the near-field region contributes to the Ga-As re-bonding. However, a large lateral dimension and repeated fracture increase the roughness of fractured surfaces and hinders self-healing of GaAs NWs. As the lateral dimension of a GaAs NW increases from 2.3 to 9.2 nm, 65% of surface attraction is lost and the healing efficiency reduces by 46%. For NWs with a lateral dimension of 5.5 nm at 300 K, the restored tensile strength decreases by 64% after 24 healing cycles, and then

saturates to a healing efficiency of 27%. The thermal motion of surface atoms increases the mismatch of atoms between two fracture surfaces during an attaching operation, which causes fluctuations in the healing efficiency. Atomic diffusion induced by an annealing treatment helps to eliminate the mismatch and enhances the healing efficiency. The present study provides useful insights into the self-healing mechanisms of GaAs NWs and suggests that more novel nanostructured materials such as SiC, ZnO and GaN can be designed with the ability to self-heal upon fracture.

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### **Appendix: How to remove the vibrational energy**

In ideally brittle materials, there is no energy dissipation mechanism during external loading or after brittle fracture. All the external energy input is stored as the elastic energy during external loading. After fracture, the elastic energy transfers to vibration energy that can be dissipated by the heat exchange between specimen and environment within several seconds or minutes. During vibration, the internal energy  $E$  of a system can be written as

$$E = E_k + E_p, \tag{A1}$$



where  $E_k$  and  $E_p$  are the kinetic energy and the potential energy, respectively. The minimum value of  $E_p$  corresponds to a zero stress state, a vibrational system rebounding to its original shape. In molecular dynamics simulations, it is impractical to dissipate such a real physical vibration by thermostat. Therefore, we adopt the following approach to remove the vibration. First, we intensify data records around the expected fracture strain. As stress reduces to 0 after fracture, we extract the corresponding configuration and remove atoms' velocities, as shown in Fig. 10. Thereafter the sample is relaxed at a desired temperature before a further attaching operation is applied.

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## Figure captions

- FIG. 1. (a) Transmission electron microscopy image of an individual GaAs NW and (b) the corresponding computational model.
- FIG. 2. Self-healing of a fractured GaAs NW. (a) The three-stage healing process: attaching, contacting and healing. Insets show patterns at two peaks (A and B) in the healing stage. (b) Stress *versus* strain curves of a virginal and self-healed GaAs NW.
- FIG. 3. Size-dependent mechanical behaviors of GaAs NWs. (a) Plastic behavior is seen as the lateral dimension of NWs is less than 2.3 nm, while brittle failure occurs in NWs with larger lateral dimensions. Insets show typical patterns of plastic deformation and brittle fracture. Young's modulus and tensile strength are plotted in (b) as functions of the lateral dimension.
- FIG. 4. Brittle fracture of a GaAs NW with the lateral dimension of 9.2 nm. (a) Five adjacent Ga-As layers. Bigger and smaller spheres represent Ga and As, respectively. Atoms on each layer are denoted by the same color. (b) Brittle fracture occurs through breaking of Ga-As bonds at the middle layer. (c) Ga-As bonds breaking at neighboring layers lead to the formation of stripping flaps as two fractured sections separate (indicated by arrows).
- FIG. 5. Size-dependent self-healing behavior of a fractured GaAs NW. (a) Fracture morphologies and (b) surface attraction and healing efficiency *versus* the lateral dimension, respectively.
- FIG. 6. Effect of repeated fracture and cure in a fractured GaAs NW. (a) and (b) show that the restored tensile strength and Young's modulus vary with healing cycles. Dashed lines are their virginal values of 9.27 and 138.7 GPa, respectively.
- FIG. 7. Fracture morphologies and self-healed patterns at different healing cycles.
- FIG. 8. Influence of temperature on the self-healing behavior of a GaAs NW with the lateral

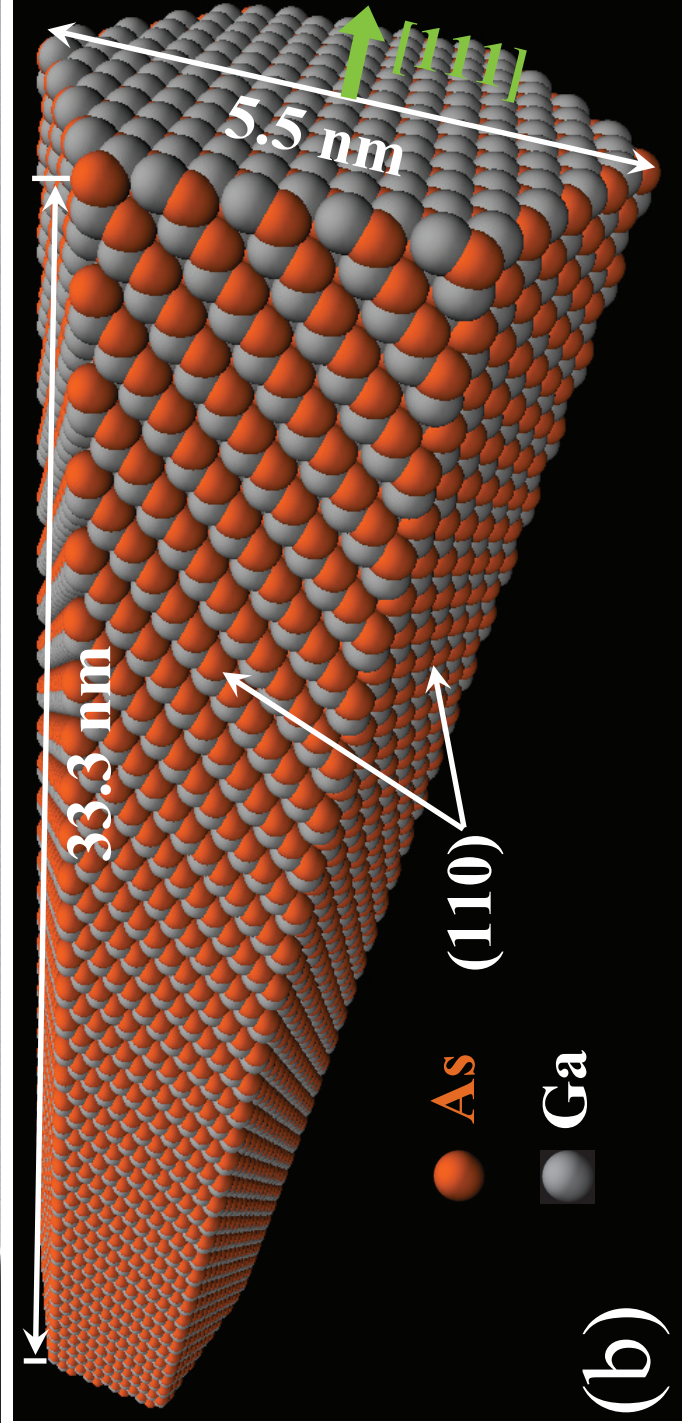
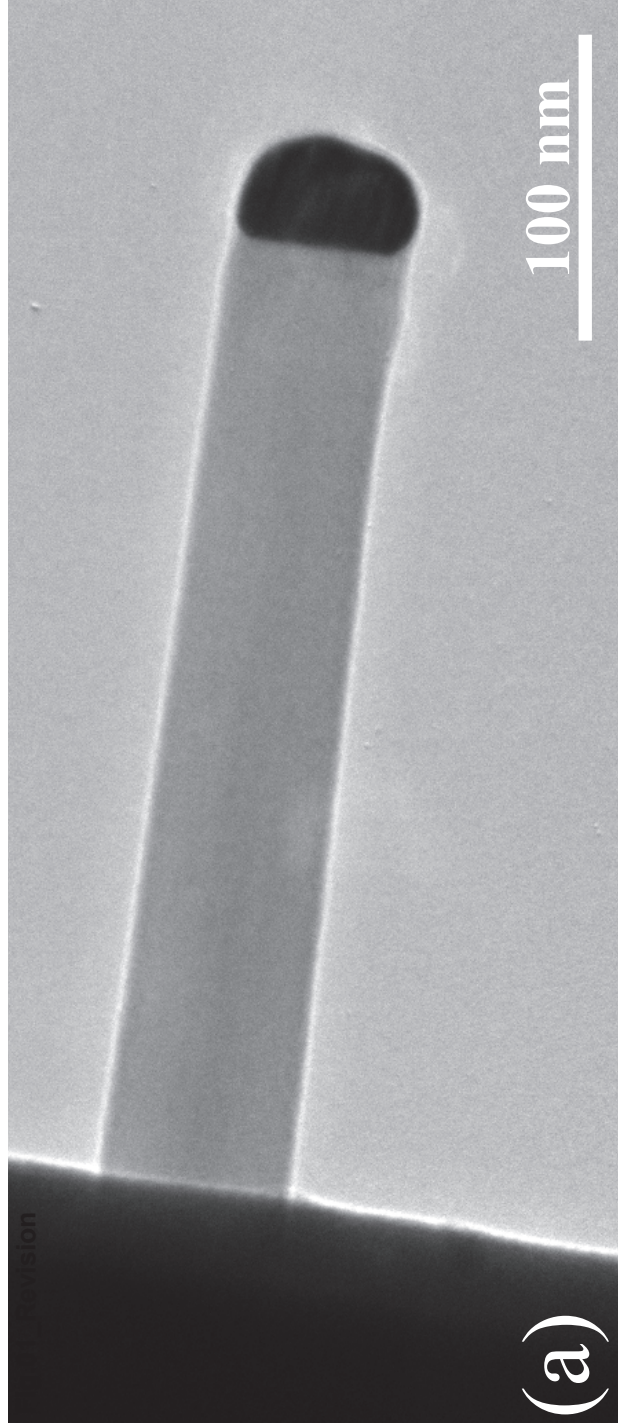
dimension of 5.5 nm. (a) The healing efficiency and restored Young's modulus *versus* temperature, where dashed line indicates the virginal Young's modulus of 138.7 GPa, and (b) the corresponding surface attraction.

FIG. 9. Healing efficiency *versus* the annealing time, where insets show snapshots at different annealing times under 1400 K. Arrows indicate a small reconstructed (111) surface at the healing site.

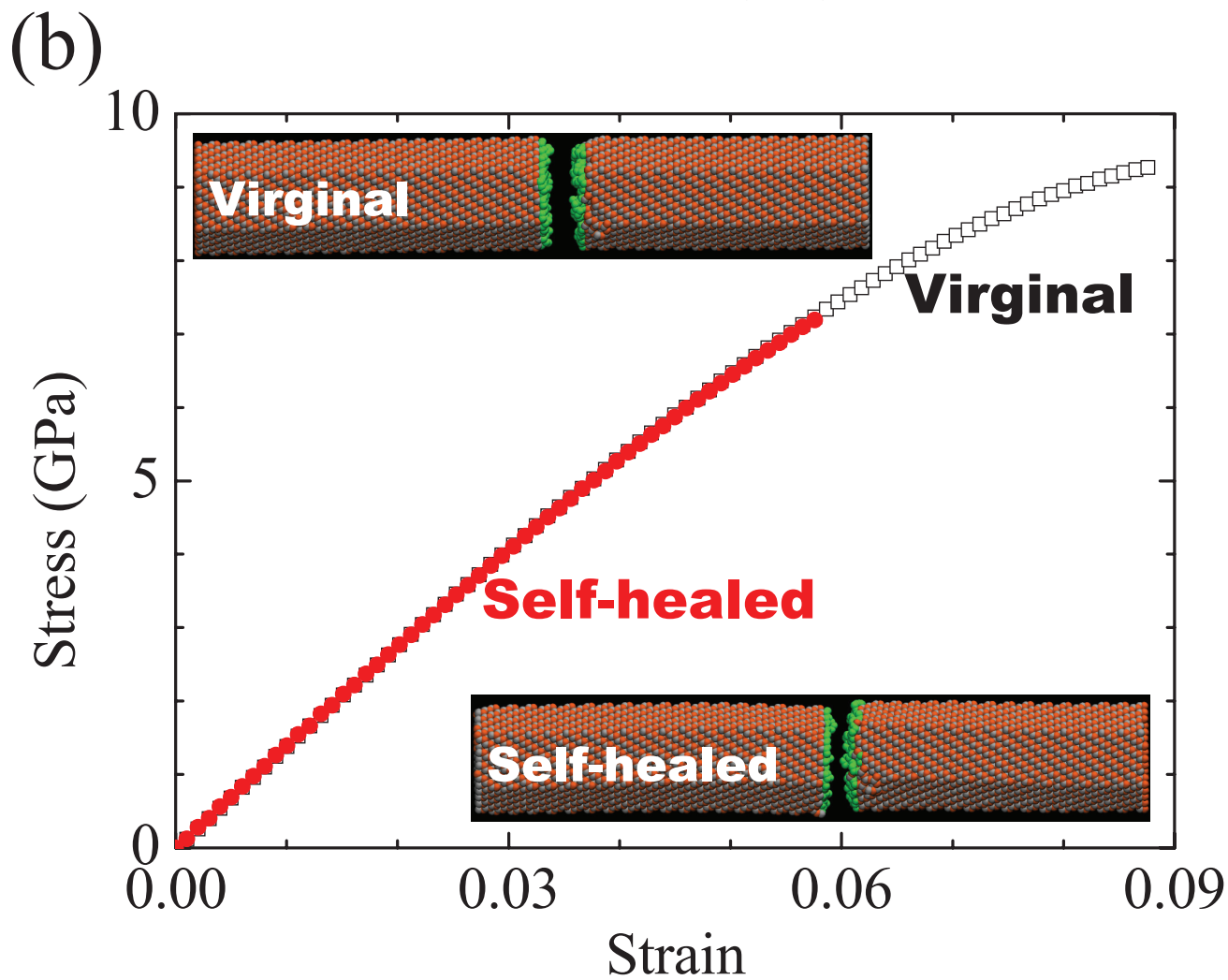
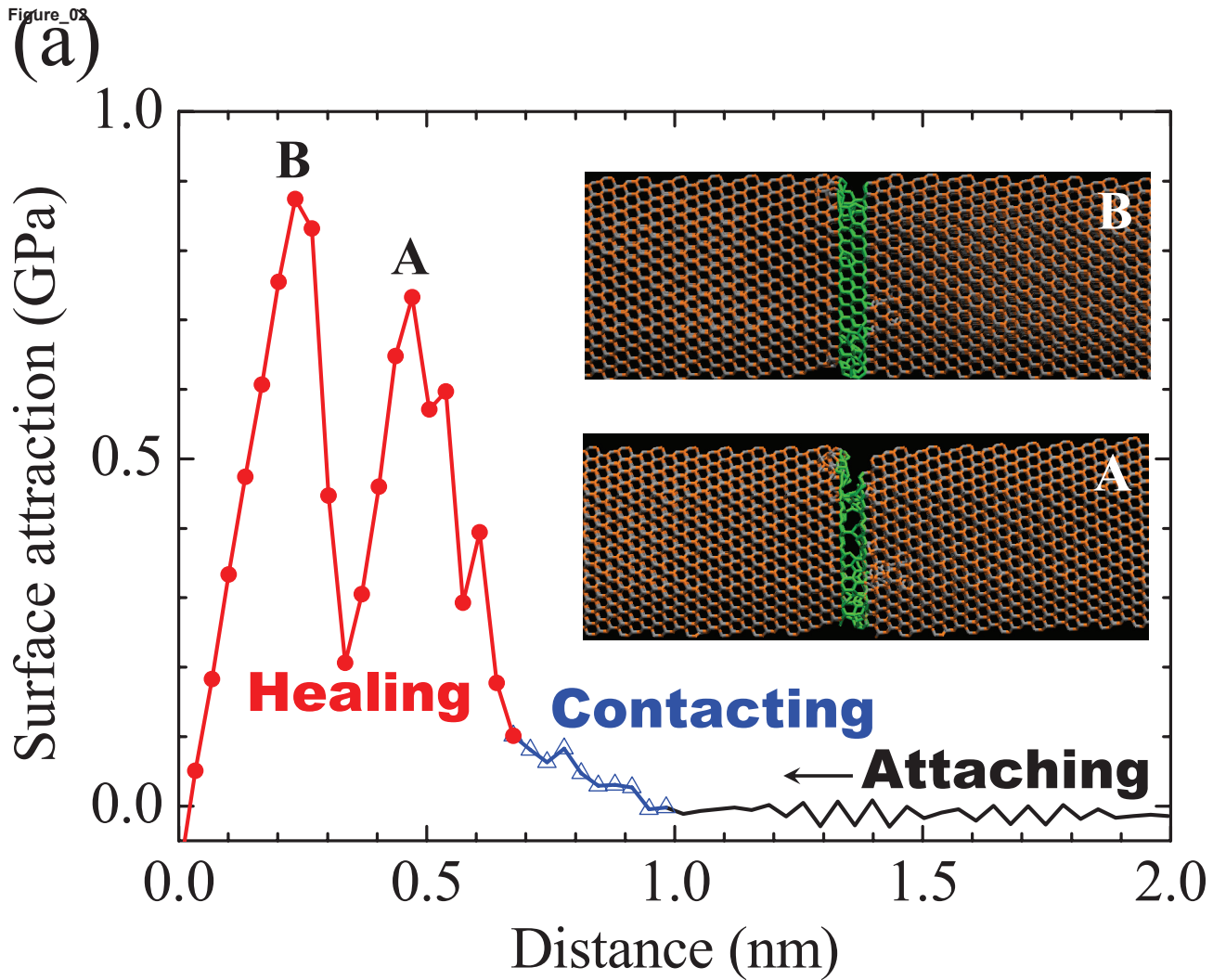
FIG. 10. Removal of vibrational energy. Stress and strain data are taken from tensile tests after the 3<sup>rd</sup> healing cycle.

**Table 1.** Two-body potential parameters used in the interaction potential of GaAs NWs, where  $r_{1s} = 0.5$  nm,  $r_{4s} = 0.375$  nm, and  $r_c = 0.75$  nm [19]; see Eqs. (1) to (4). Here  $e$  represents the electronic charge.

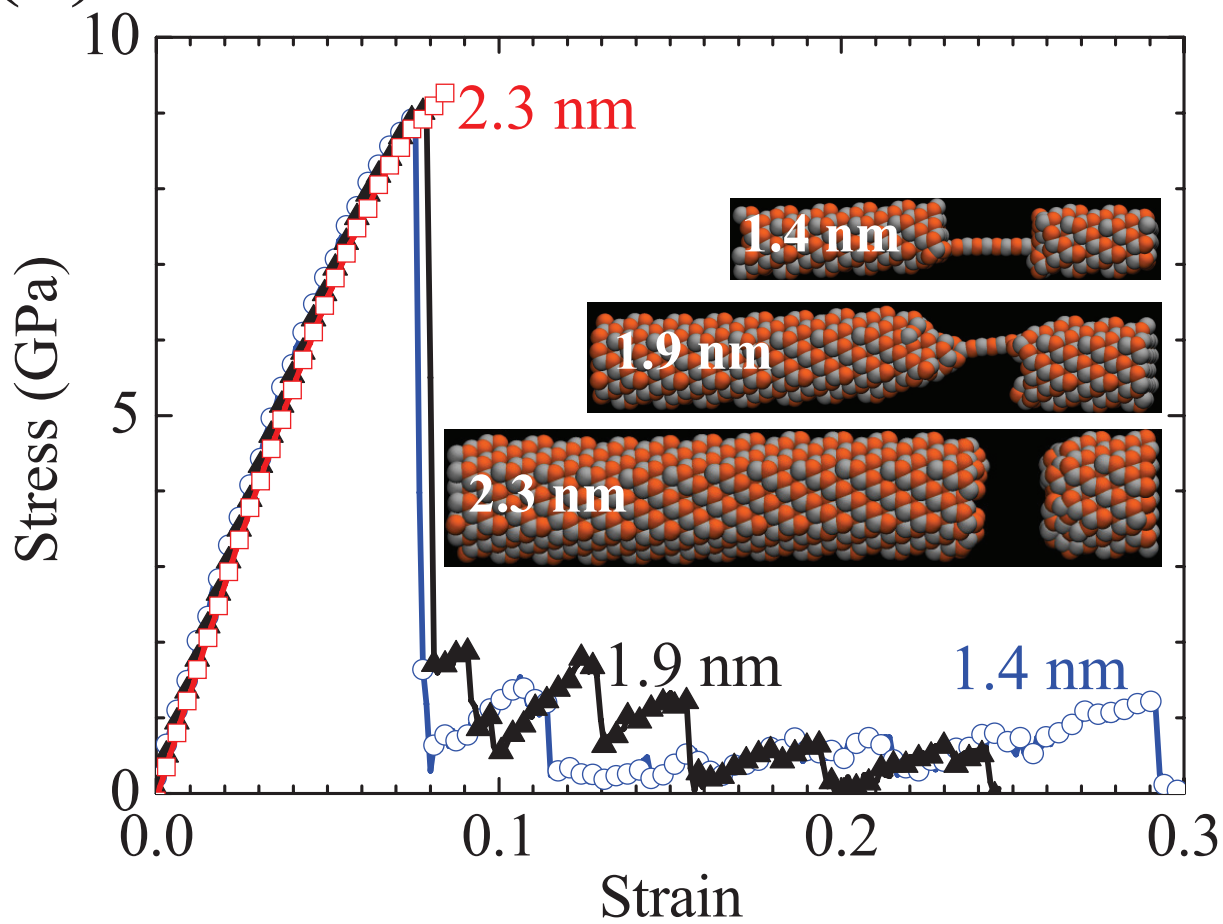
Atom type	$\sigma$ (nm)	$\alpha$ (nm <sup>3</sup> )	$Z_i$ ( $e$ )	$A_{ij}$ ( $10^{-19}$ J)	$\eta_{ij}$	$W_{ij}$ ( $10^{-24}$ J nm <sup>6</sup> )
Ga	0.095	0	0.9418			
As	0.1498	0.002	-0.9418			
Ga-Ga				16.4984	7	0
Ga-As				2.0623	9	58.916
As-As				2.0623	7	0



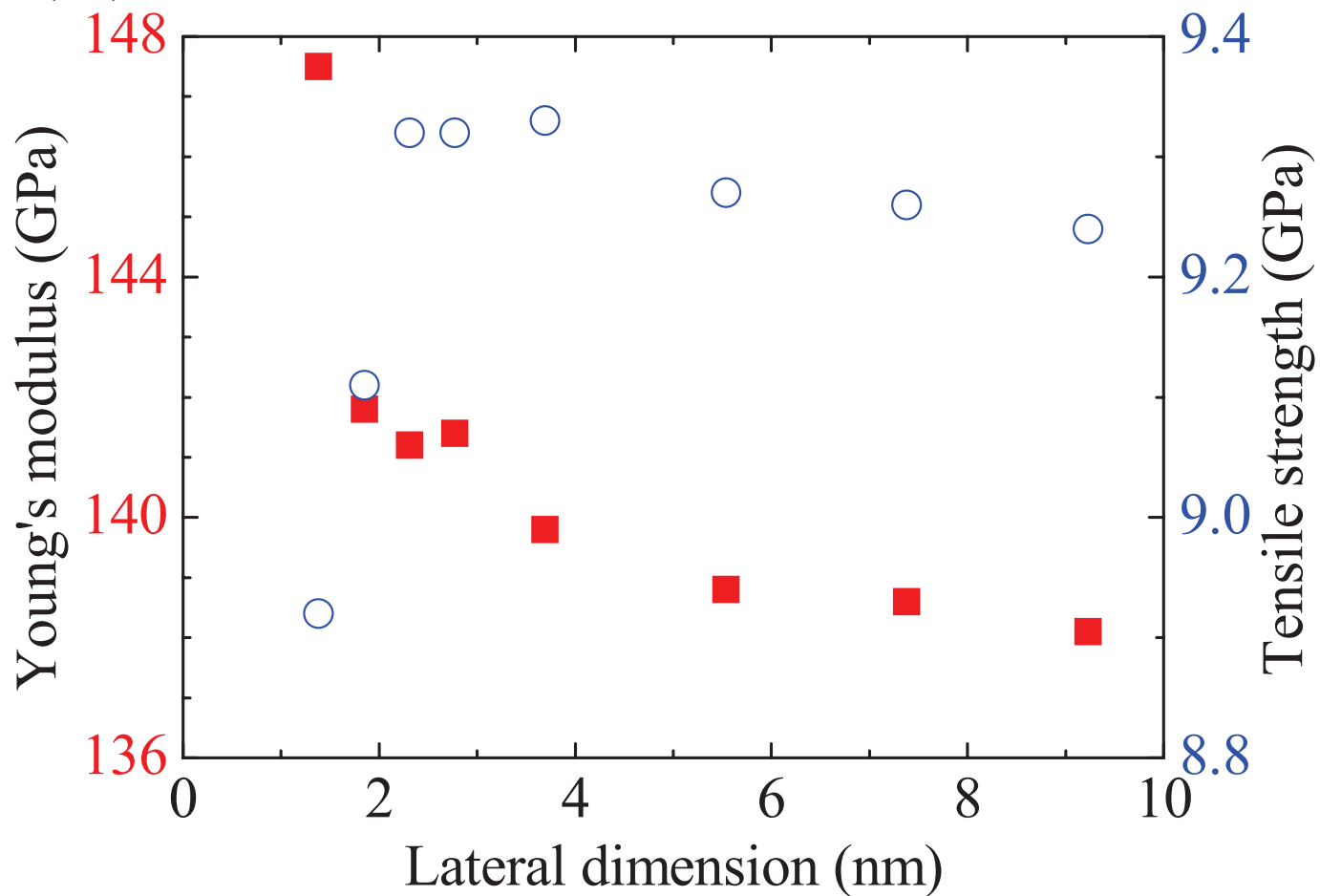




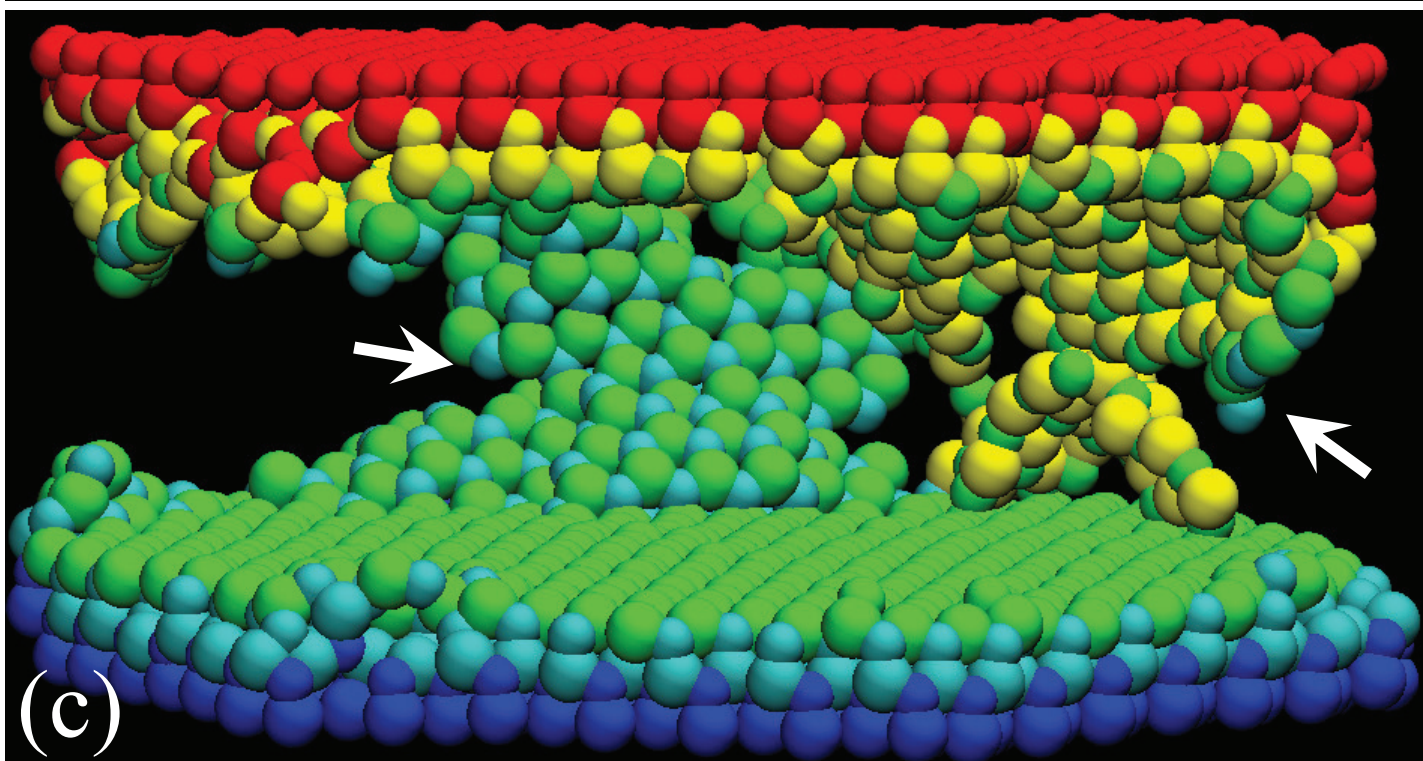
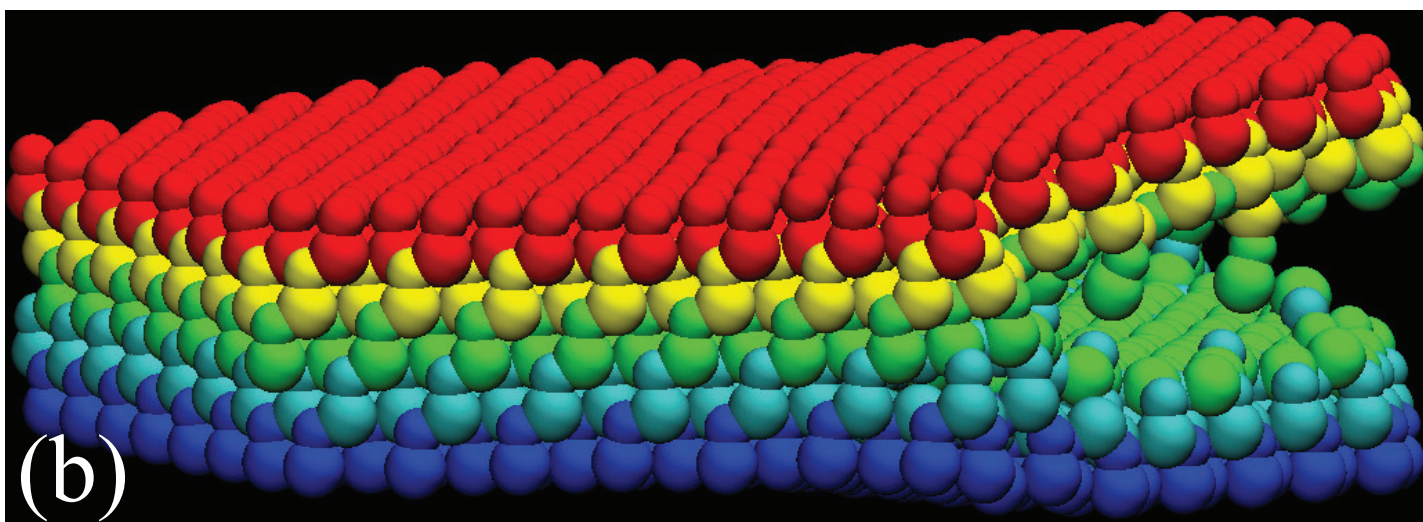
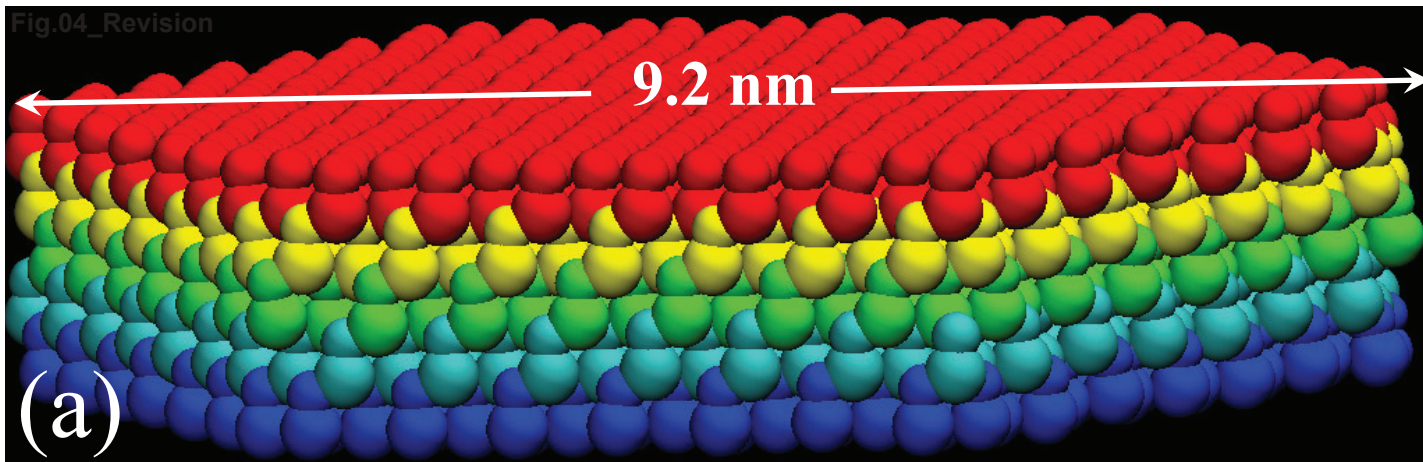
(a)



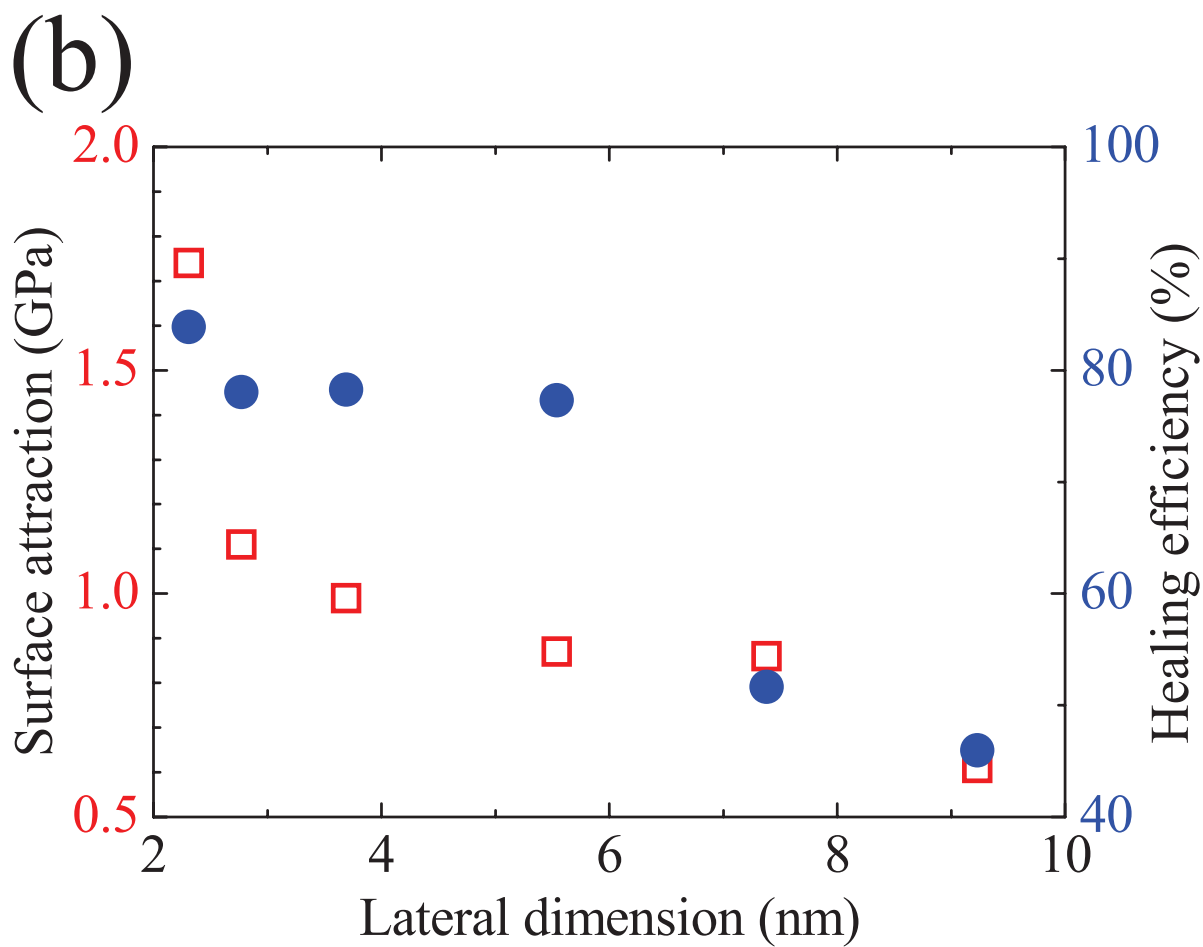
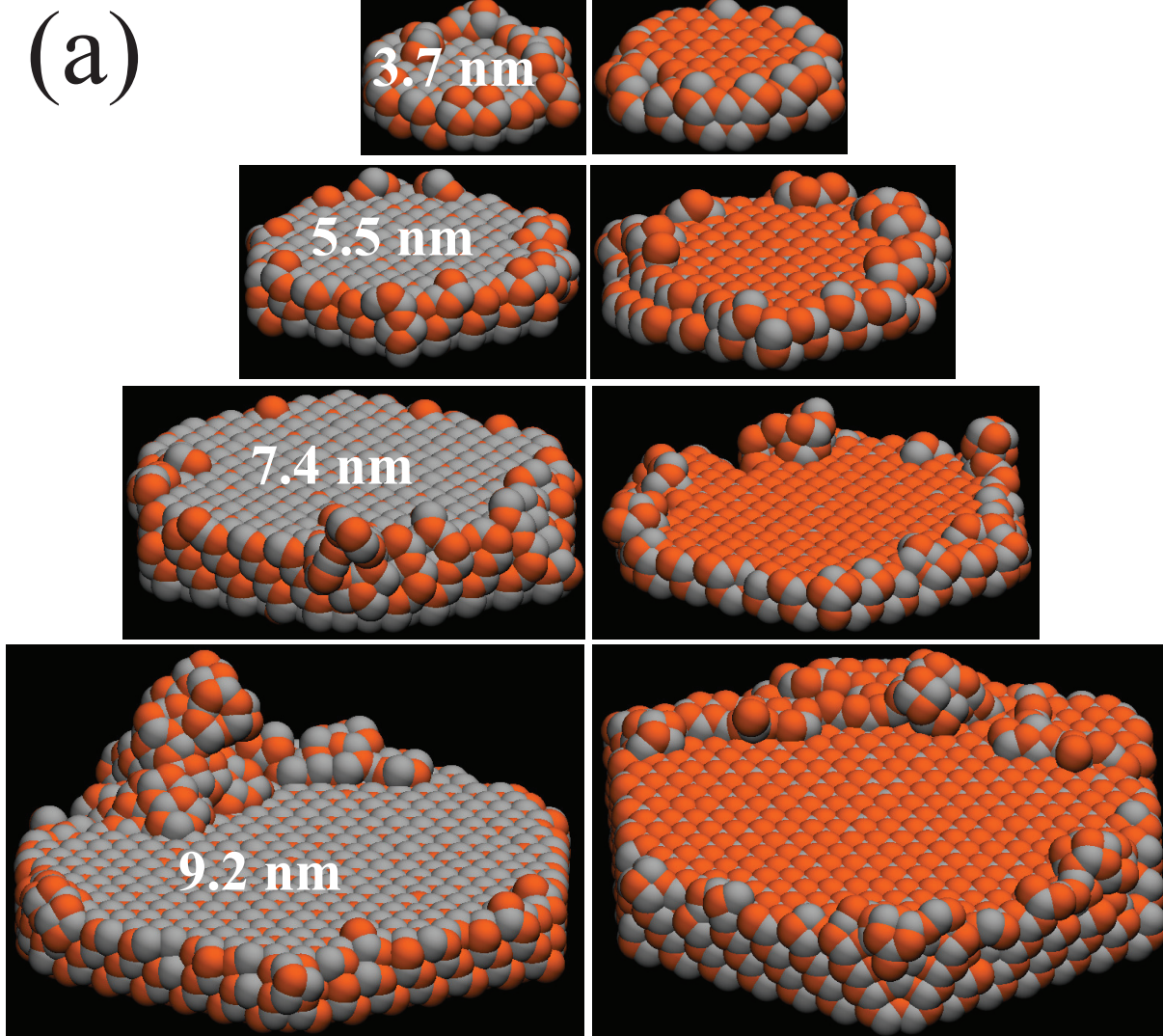
(b)



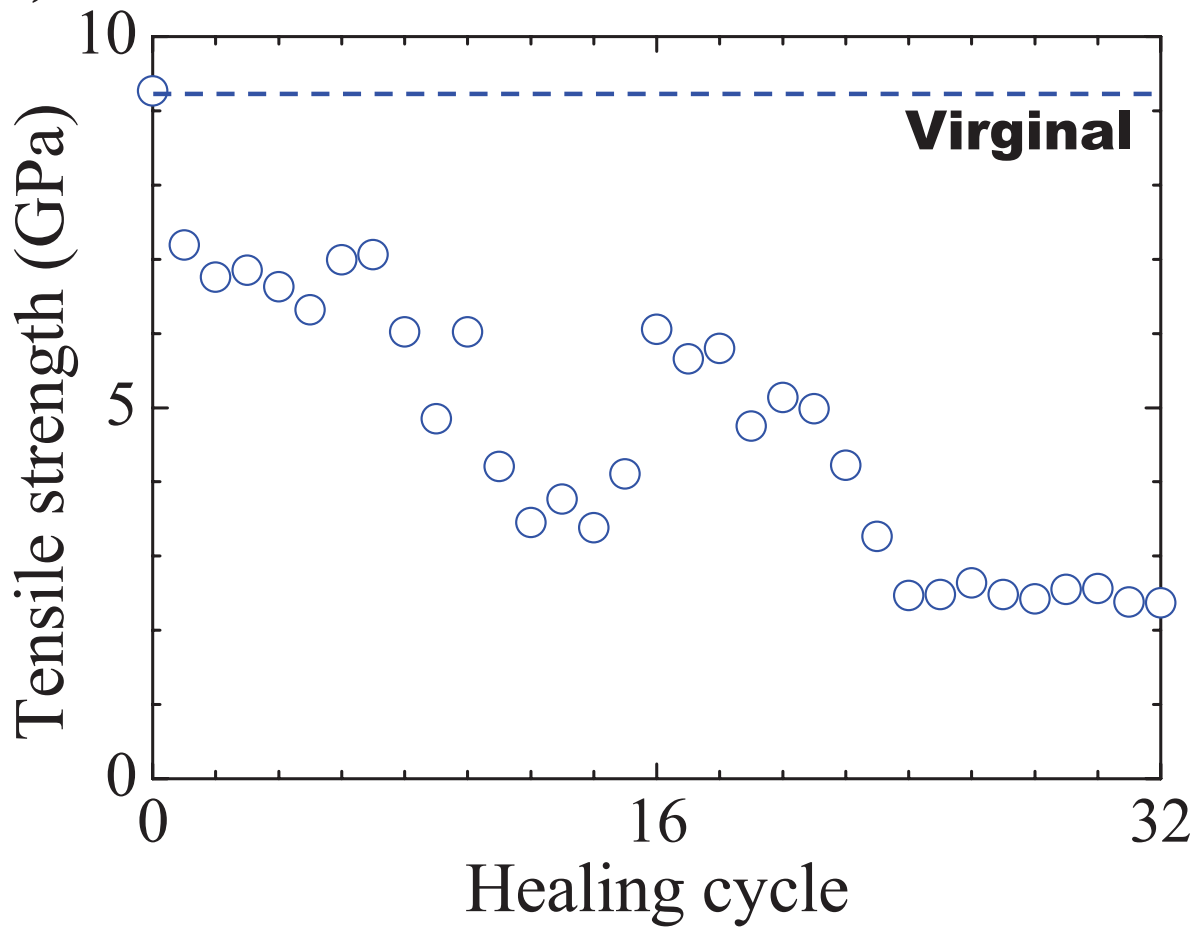




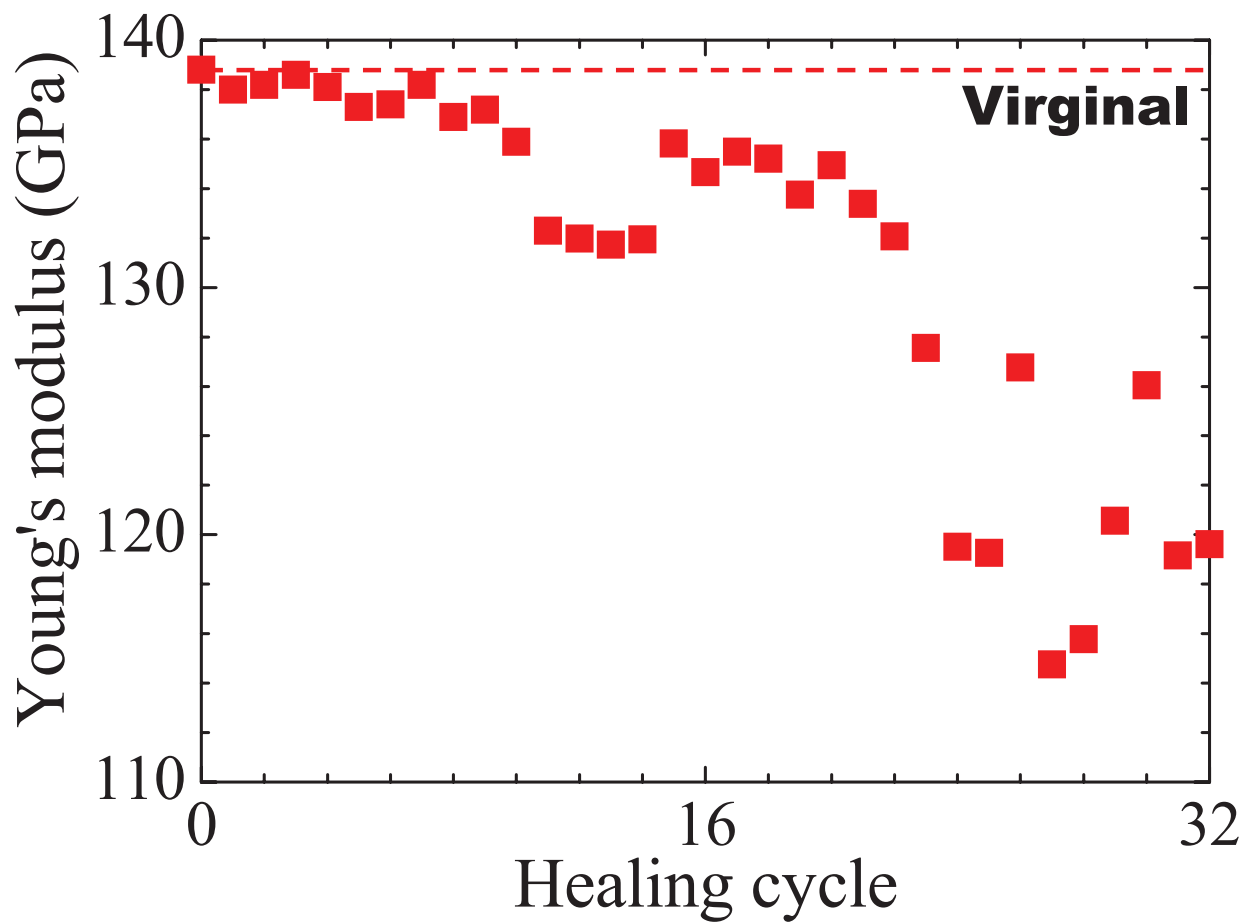




(a)



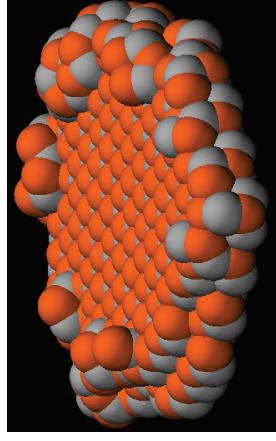
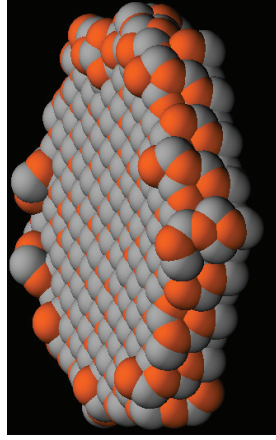
(b)



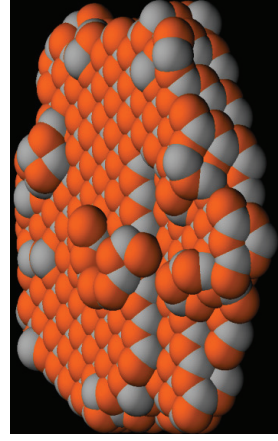
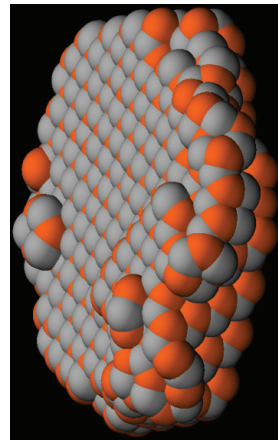


# Fracture morphology

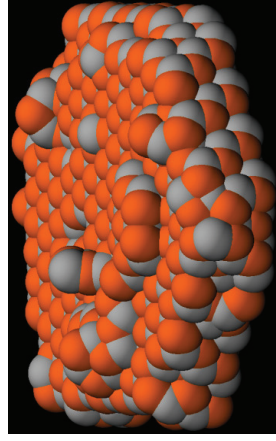
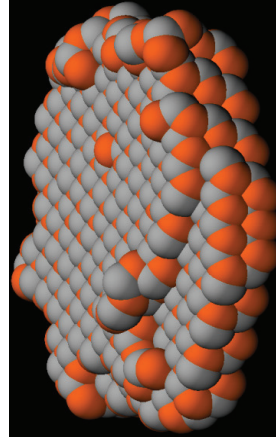
# Self-healed pattern



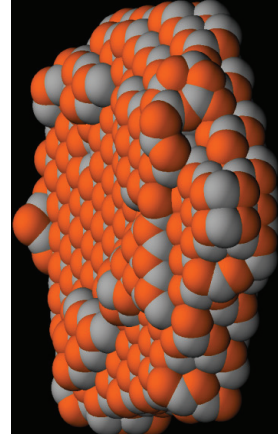
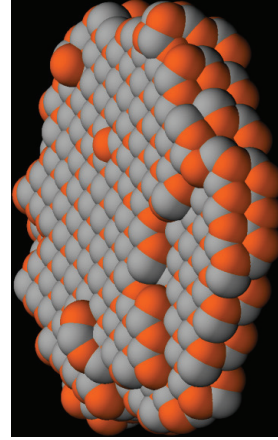
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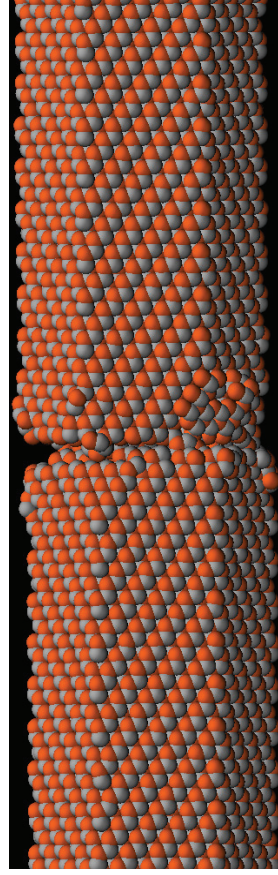
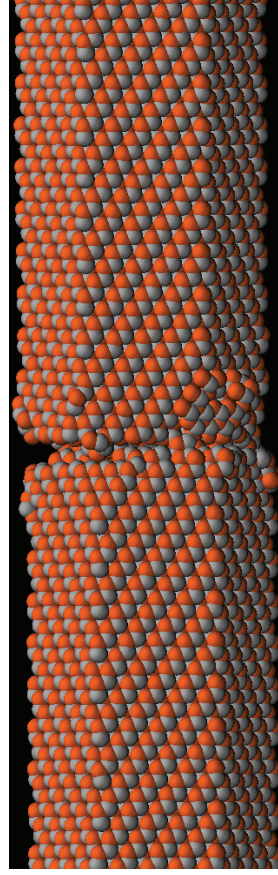
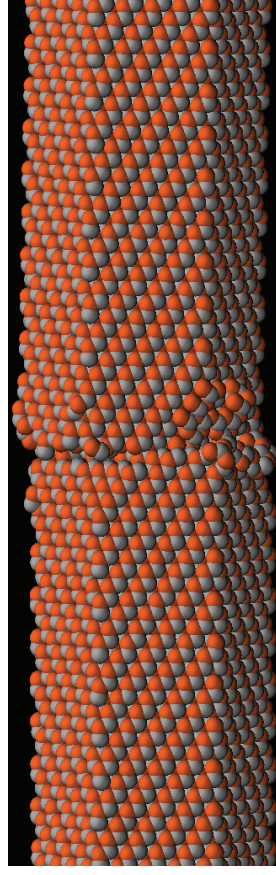
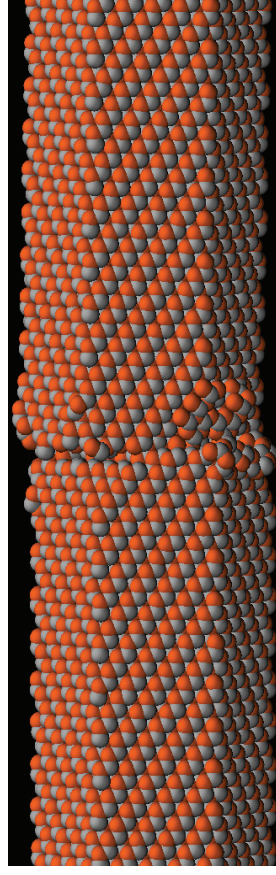
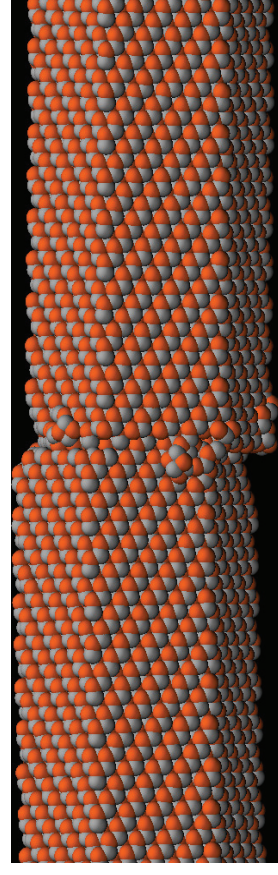
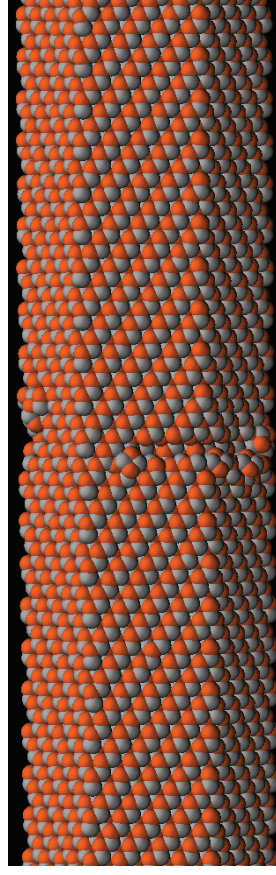
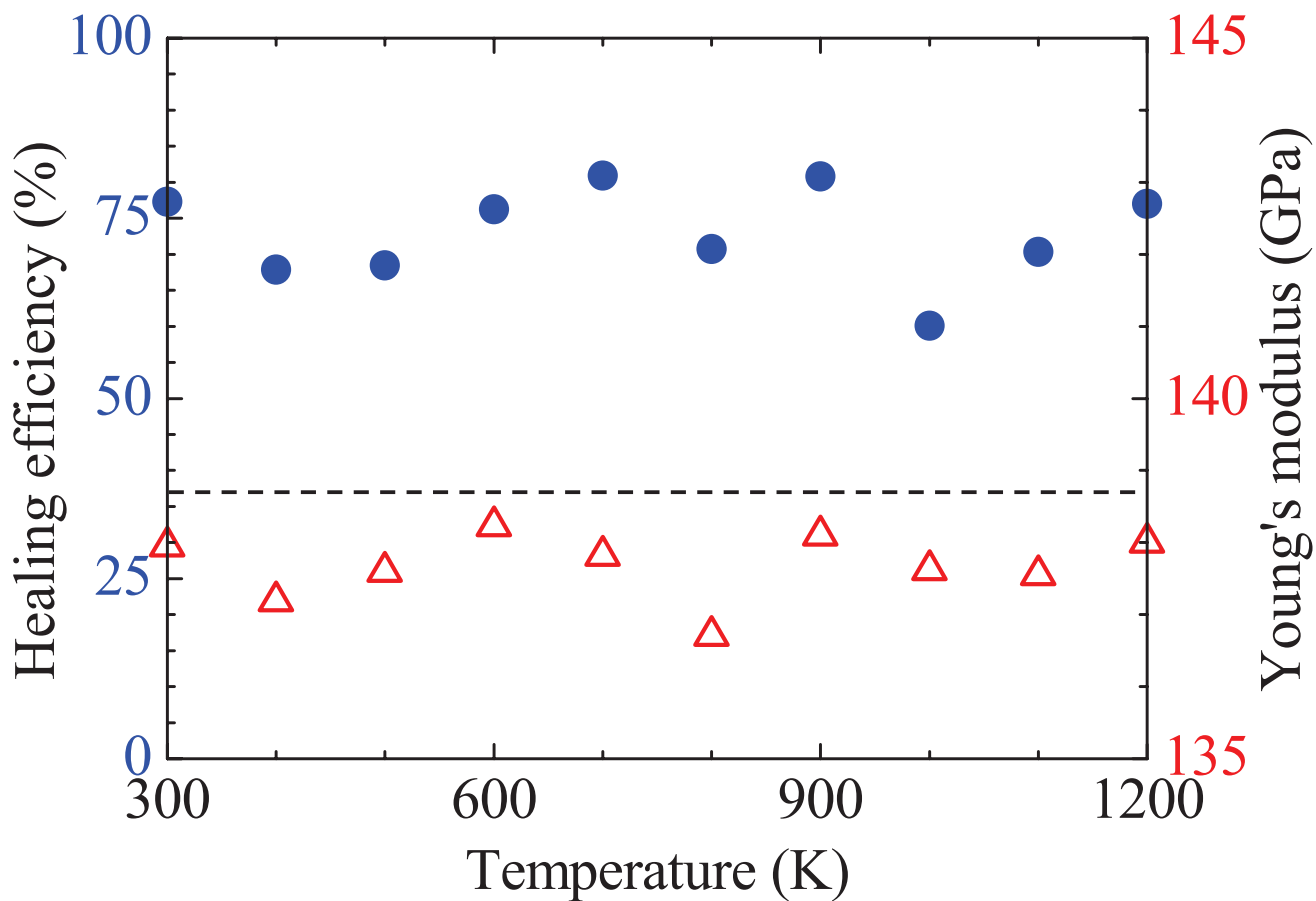
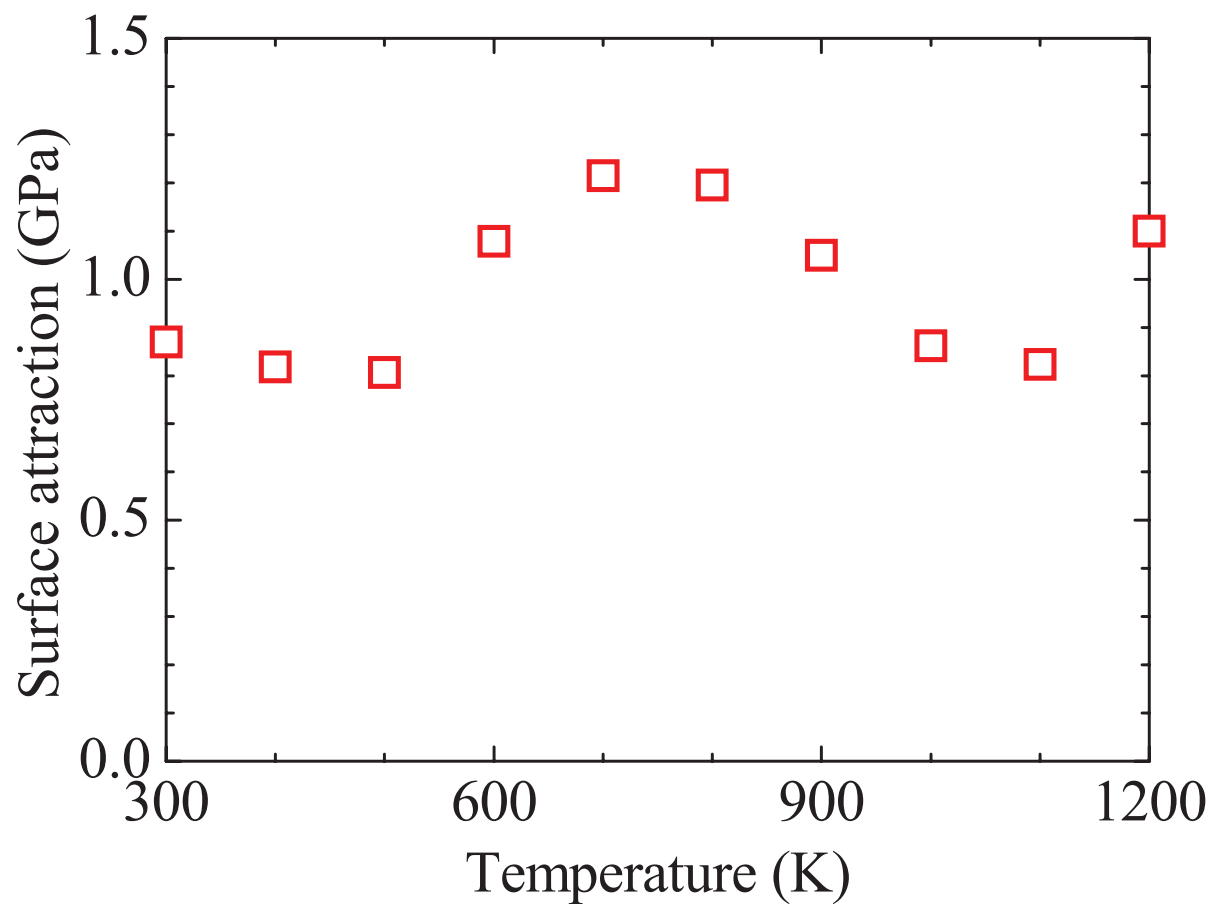


Figure 08

(a)



(b)





Figure\_09

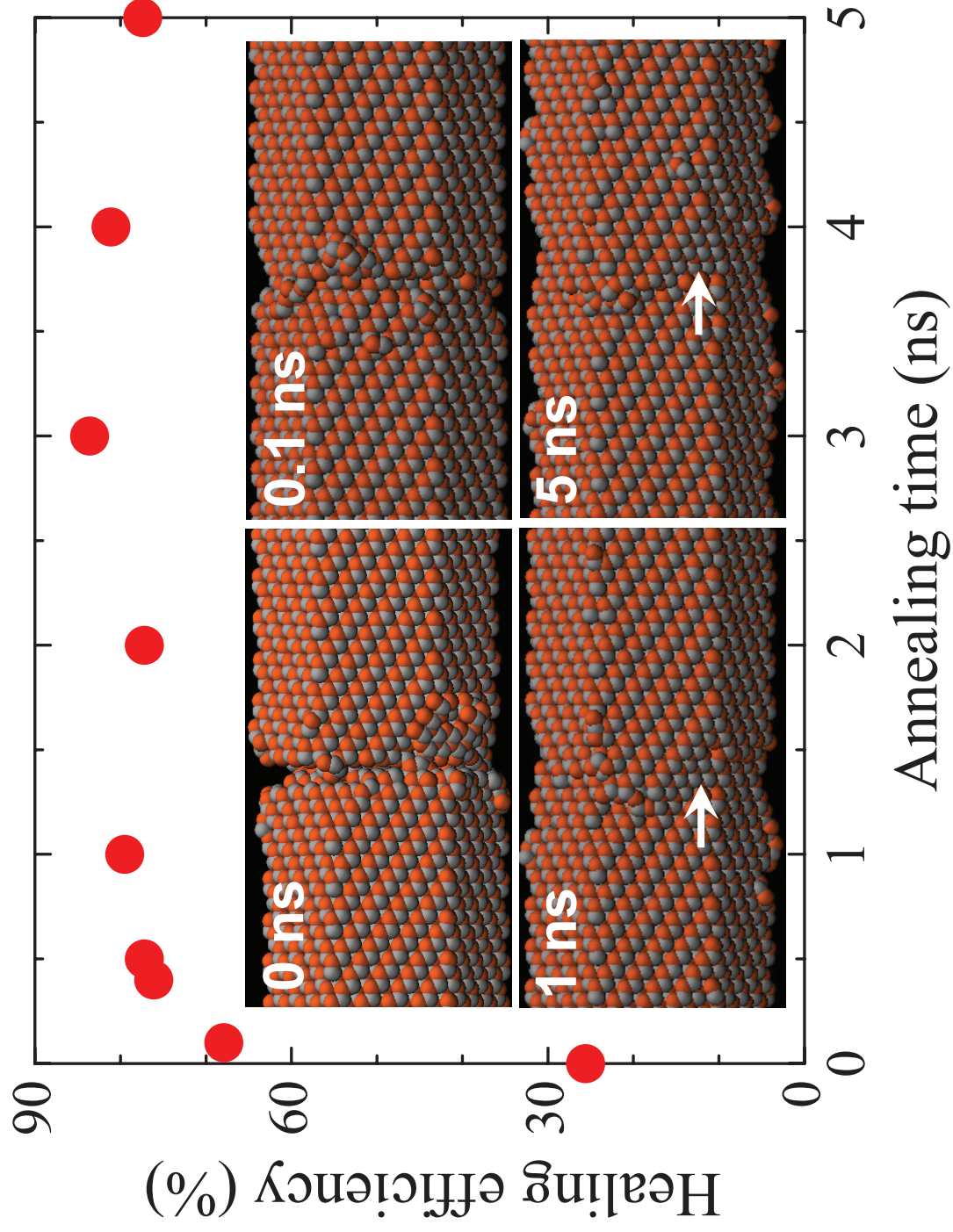




Fig.10\_Revision

